

10-12-01  
IN THE UNITED STATES PATENT AND TRADEMARK OFFICECommissioner for Patents  
BOX PATENT APPLICATION  
Washington, D.C. 20231

Dated: October 10, 2001

Our Case Docket No.: SHX 326

Sir:

Transmitted herewith for filing is the patent application of Inventor: Masae Yoyasu.

For: AUTOMOBILE MOLDING AND FASTENER THEREFOR

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J1002 U.S. PRO  
09/975284  
10/10/01  


Enclosed are also:

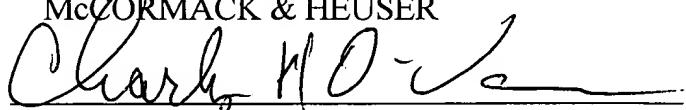
11 sheets of drawings.  
 Declaration/Power of Attorney.  
 Information Disclosure Statement.  
 Assignment of the Invention to Hashimoto Forming Industries Co. Ltd.  
 Certified Copy of Japanese Application No. 2000-314316.

## Claims as Filed — LARGE ENTITY

For	Number Filed	Number Extra	Rate	Basic Fee
Total Claims	21-20	1	\$18.00	= \$ 18.00
Independent Claims	2- 3	0	\$84.00	= \$ 0.00
<b>Total Filing</b>				
<b>Fee-----</b>				<b>\$ 758.00</b>

A check in the amount of \$798.00 to cover the filing fee and assignment recordation fee is enclosed.  
 The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Account No. 11-1540. A duplicate copy of this sheet is enclosed.

Respectfully submitted,  
 KOLISCH, HARTWELL, DICKINSON,  
 McCORMACK & HEUSER



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CHD:gp  
 Enclosures

“Express Mail” Mailing Label No. EL920480861US  
 Date of Deposit - October 10, 2001

EL920480861US

I hereby certify that the attached Patent Application of Masae Yoyasu, entitled AUTOMOBILE MOLDING AND FASTENER THEREFOR, accompanied by 11 sheets of drawings, a Preliminary Amendment, a Declaration and Power of Attorney, an Information Disclosure Statement, an Assignment, a certified copy of Japanese Application No. 2000-314316, and a check in the amount of \$798.00, is being deposited with the United States Postal Service “Express Mail Post Office to Addressee” service under 37 C.F.R. 1.10 on the date indicated above and is addressed to the Commissioner for Patents, Washington, D.C. 20231.

  
 (Signature of Person Mailing)